







(1.27 mm) .050"

FW-SM SERIES

OPTION

(15.49 mm) .610"

-EP

(5.46 mm) .215"

–A

= Alignment Pin (3 positions min.) (5.46 mm) .215" to

(15.75 mm) .620"

= Pick & Place Pad

(5 positions min.)

= Tape & Reel (Max overall height = Post+Stacker Height+

Pad+Alignment Pin = .700 (17.78))

(0.89)

DIA

IJIJ

-EP

MT MICRO BOARD STACKER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?FW-SM

Insulator Material:

Black Liquid Crystal Polymer Terminal Material: Phosphor Bronze

Plating: Sn or Au over 50 µ" (1.27 µm) Ni Operating Temp Range: -55 °C to +125 °C RoHS Compliant:

PROCESSING

Lead-Free Solderable:

SMT Lead Coplanarity: (0.10 mm) .004" max (02-30) (0.15 mm) .006" max (31-50)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





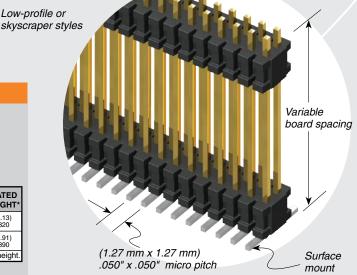
ALSO AVAILABLE (MOQ Required)

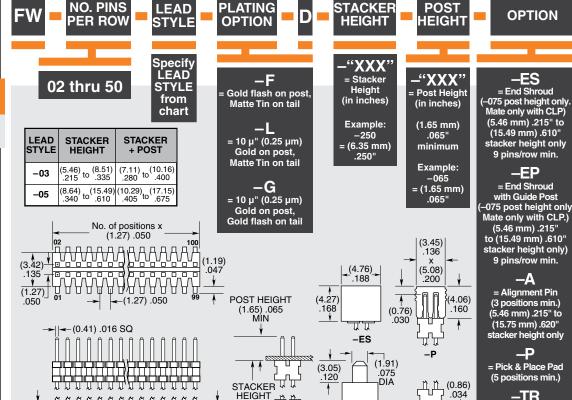
· Smaller stack heights Contact Samtec.

Board Mates:

Cable Mates:

APPLICATIONS MATED HEIGHT CLP LEAD STYLE MATED CLP HEIGHT FW FW-XX-03-X-X-233-065 02 FW-XX-03-X-X-303-065 (9.91) Processing conditions will affect mated height





Note: For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

(2.51)

Note: This Series is non-standard, non-returnable,

Due to technical progress, all designs, specifications and components are subject to change without notice. WWW.SAMTEC.COM

(2.92)